

FEATURES

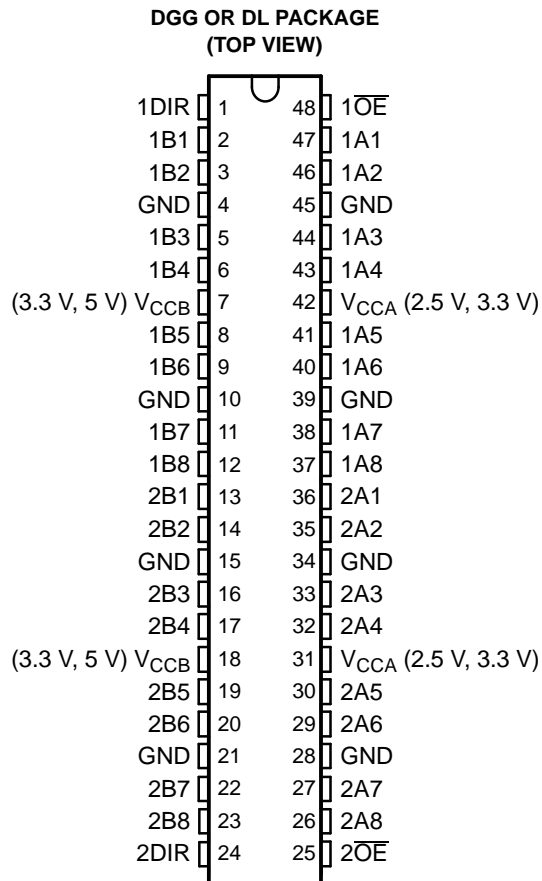
- Member of the Texas Instruments Widebus™ Family
- Max t_{pd} of 5.8 ns at 3.3-V V_{CC}
- ± 24 -mA Output Drive at 3.3-V V_{CC}
- Control Inputs V_{IH}/V_{IL} Levels Are Referenced to V_{CCA} Voltage
- Latch-Up Performance Exceeds 250 mA Per JESD 17

DESCRIPTION/ORDERING INFORMATION

This 16-bit (dual-octal) noninverting bus transceiver contains two separate supply rails. B port has V_{CCB} , which is set to operate at 3.3 V and 5 V. A port has V_{CCA} , which is set to operate at 2.5 V and 3.3 V. This allows for translation from a 2.5-V to a 3.3-V environment, and vice versa, or from a 3.3-V to a 5-V environment, and vice versa.

The SN74ALVC164245 is designed for asynchronous communication between data buses. The control circuitry (1DIR, 2DIR, $\overline{1OE}$, and $\overline{2OE}$) is powered by V_{CCA} .

To ensure the high-impedance state during power up or power down, the output-enable (\overline{OE}) input should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.



ORDERING INFORMATION

T_A	PACKAGE ⁽¹⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	SSOP - DL	Tube of 25	SN74ALVC164245DL	ALVC164245
		Reel of 1000	SN74ALVC164245DLR	
	TSSOP - DGG	Reel of 2000	SN74ALVC164245DGGR	ALVC164245
		Reel of 250	SN74ALVC164245DGGT	
	VFBGA - GQL	Reel of 1000	SN74ALVC164245KR	VC4245
	VFBGA - ZQL (Pb-free)		74ALVC164245ZQLR	

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



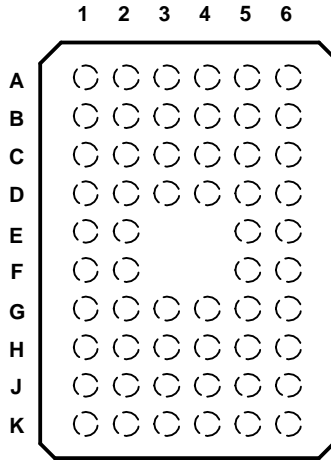
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus is a trademark of Texas Instruments.

SN74ALVC164245 16-BIT 2.5-V TO 3.3-V/3.3-V TO 5-V LEVEL-SHIFTING TRANSCEIVER WITH 3-STATE OUTPUTS

SCAS416N—MARCH 1994—REVISED JULY 2004

GQL OR ZQL PACKAGE
(TOP VIEW)



TERMINAL ASSIGNMENTS⁽¹⁾

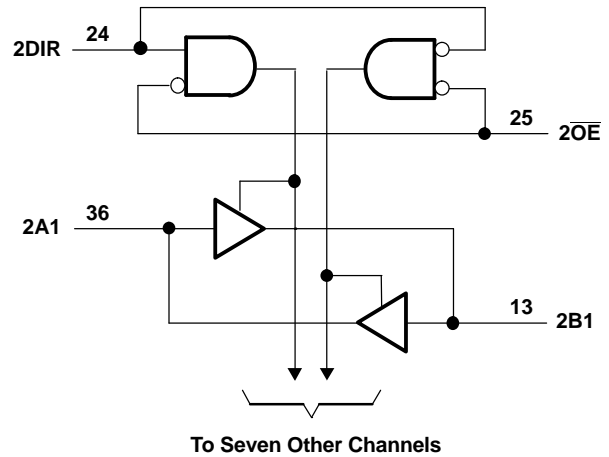
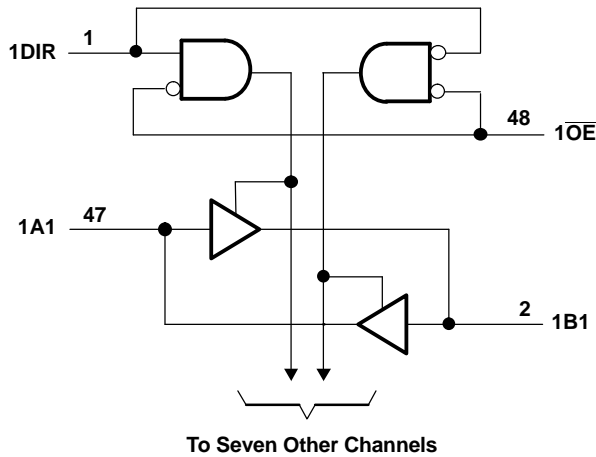
	1	2	3	4	5	6
A	1DIR	NC	NC	NC	NC	1 \overline{OE}
B	1B2	1B1	GND	GND	1A1	1A2
C	1B4	1B3	V _{CCB}	V _{CCA}	1A3	1A4
D	1B6	1B5	GND	GND	1A5	1A6
E	1B8	1B7			1A7	1A8
F	2B1	2B2			2A2	2A1
G	2B3	2B4	GND	GND	2A4	2A3
H	2B5	2B6	V _{CCB}	V _{CCA}	2A6	2A5
J	2B7	2B8	GND	GND	2A8	2A7
K	2DIR	NC	NC	NC	NC	2 \overline{OE}

(1) NC – No internal connection

FUNCTION TABLE
(each 8-bit section)

INPUTS		OPERATION
\overline{OE}	DIR	
L	L	B data to A bus
L	H	A data to B bus
H	X	Isolation

LOGIC DIAGRAM (POSITIVE LOGIC)



Pin numbers shown are for the DGG and DL packages.

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

 over operating free-air temperature range for V_{CCB} at 5 V and V_{CCA} at 3.3 V (unless otherwise noted)

		MIN	MAX	UNIT	
V_{CC}	Supply voltage range	V_{CCA}	-0.5	4.6	V
		V_{CCB}	-0.5	6	
V_I	Input voltage range	Except I/O ports ⁽²⁾	-0.5	6	V
		I/O port A ⁽³⁾	-0.5	$V_{CCA} + 0.5$	
		I/O port B ⁽²⁾	-0.5	$V_{CCB} + 0.5$	
I_{IK}	Input clamp current	$V_I < 0$		-50	mA
I_{OK}	Output clamp current	$V_O < 0$		-50	mA
I_O	Continuous output current			±50	mA
	Continuous current through each V_{CC} or GND			±100	mA
θ_{JA}	Package thermal impedance ⁽⁴⁾	DGG package		70	°C/W
		DL package		63	
		GQL/ZQL package		42	
T_{stg}	Storage temperature range	-65	150		°C

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) This value is limited to 6 V, maximum.
- (3) This value is limited to 4.6 V, maximum.
- (4) The package thermal impedance is calculated in accordance with JESD 51-7.

RECOMMENDED OPERATING CONDITIONS⁽¹⁾

 for V_{CCB} at 3.3 V and 5 V

		MIN	MAX	UNIT
V_{CCB}	Supply voltage	3	5.5	V
V_{IH}	High-level input voltage	2		V
V_{IL}	Low-level input voltage	$V_{CCB} = 3\text{ V to }3.6\text{ V}$	0.7	V
		$V_{CCB} = 4.5\text{ V to }5.5\text{ V}$	0.8	
V_{IB}	Input voltage	0	V_{CCB}	V
V_{OB}	Output voltage	0	V_{CCB}	V
I_{OH}	High-level output current		-24	mA
I_{OL}	Low-level output current		24	mA
$\Delta t/\Delta v$	Input transition rise or fall rate		10	ns/V
T_A	Operating free-air temperature	-40	85	°C

- (1) All unused inputs of the device must be held at the associated V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

SN74ALVC164245

16-BIT 2.5-V TO 3.3-V/3.3-V TO 5-V LEVEL-SHIFTING TRANSCEIVER WITH 3-STATE OUTPUTS

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RECOMMENDED OPERATING CONDITIONS⁽¹⁾

for V_{CCA} at 2.5 V and 3.3 V

		MIN	MAX	UNIT
V_{CCA}	Supply voltage	2.3	3.6	V
V_{IH}	High-level input voltage	$V_{CCA} = 2.3 \text{ V to } 2.7 \text{ V}$		V
		$V_{CCA} = 3 \text{ V to } 3.6 \text{ V}$		
V_{IL}	Low-level input voltage	$V_{CCA} = 2.3 \text{ V to } 2.7 \text{ V}$		V
		$V_{CCA} = 3 \text{ V to } 3.6 \text{ V}$		
V_{IA}	Input voltage	0	V_{CCA}	V
V_{OA}	Output voltage	0	V_{CCA}	V
I_{OH}	High-level output current	$V_{CCA} = 2.3 \text{ V}$		mA
		$V_{CCA} = 3 \text{ V}$		
I_{OL}	Low-level output current	$V_{CCA} = 2.3 \text{ V}$		mA
		$V_{CCA} = 3 \text{ V}$		
$\Delta t/\Delta v$	Input transition rise or fall rate		10	ns/V
T_A	Operating free-air temperature	-40	85	°C

(1) All unused inputs of the device must be held at the associated V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range for $V_{CCA} = 2.7 \text{ V to } 3.6 \text{ V}$ and $V_{CCB} = 4.5 \text{ V to } 5.5 \text{ V}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V_{CCA}	V_{CCB}	MIN	TYP ⁽¹⁾	MAX	UNIT
V_{OH}	B to A	$I_{OH} = -100 \mu\text{A}$	2.7 V to 3.6 V		$V_{CC} - 0.2$		V	
		$I_{OH} = -12 \text{ mA}$	2.7 V		2.2			
		$I_{OH} = -24 \text{ mA}$	3 V		2.4			
	A to B	$I_{OH} = -100 \mu\text{A}$		4.5 V	4.3			
		$I_{OH} = -12 \text{ mA}$		5.5 V	5.3			
		$I_{OH} = -24 \text{ mA}$		4.5 V	3.7			
V_{OL}	B to A	$I_{OL} = 100 \mu\text{A}$	2.7 V to 3.6 V				V	
		$I_{OL} = 12 \text{ mA}$	2.7 V		0.4			
		$I_{OL} = 24 \text{ mA}$	3 V		0.55			
	A to B	$I_{OL} = 100 \mu\text{A}$		4.5 V to 5.5 V	0.2			
		$I_{OL} = 12 \text{ mA}$		4.5 V to 5.5 V	0.55			
		$I_{OL} = 24 \text{ mA}$		4.5 V to 5.5 V	0.55			
I_I	Control inputs	$V_I = V_{CCA}/V_{CCB}$ or GND	3.6 V	5.5 V			±5	μA
I_{OZ} ⁽²⁾	A or B ports	$V_O = V_{CCA}/V_{CCB}$ or GND	3.6 V	5.5 V			±10	μA
I_{CC}		$V_I = V_{CCA}/V_{CCB}$ or GND, $I_O = 0$	5.5 V	5.5 V			40	μA
ΔI_{CC} ⁽³⁾		One input at $V_{CCA}/V_{CCB} - 0.6 \text{ V}$, Other inputs at V_{CCA}/V_{CCB} or GND	3 V to 3.6 V	4.5 V to 5.5 V			750	μA
C_i	Control inputs	$V_I = V_{CCA}/V_{CCB}$ or GND	3.3 V	5 V		6.5		pF
C_{iO}	A or B ports	$V_O = V_{CCA}/V_{CCB}$ or GND	3.3 V	3.3 V		8.5		pF

(1) Typical values are measured at $V_{CCA} = 3.3 \text{ V}$ and $V_{CCB} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$.

(2) For I/O ports, the parameter I_{OZ} includes the input leakage current.

(3) This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than at 0 or the associated V_{CC} .

ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range for $V_{CCA} = 2.3 \text{ V to } 2.7 \text{ V}$ and $V_{CCB} = 3 \text{ V to } 3.6 \text{ V}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V_{CCA}	V_{CCB}	MIN	MAX	UNIT
V_{OH}	B to A	$I_{OH} = -100 \mu\text{A}$	2.3 V to 2.7 V	3 V to 3.6 V	$V_{CCA} - 0.2$		V
		$I_{OH} = -8 \text{ mA}$	2.3 V	3 V to 3.6 V	1.7		
		$I_{OH} = -12 \text{ mA}$	2.7 V	3 V to 3.6 V	1.8		
	A to B	$I_{OH} = -100 \mu\text{A}$	2.3 V to 2.7 V	3 V to 3.6 V	$V_{CCB} - 0.2$		
		$I_{OH} = -18 \text{ mA}$	2.3 V to 2.7 V	3 V	2.2		
V_{OL}	B to A	$I_{OL} = 100 \mu\text{A}$	2.3 V to 2.7 V	3 V to 3.6 V	0.2		V
		$I_{OL} = 12 \text{ mA}$	2.3 V	3 V to 3.6 V	0.6		
	A to B	$I_{OL} = 100 \mu\text{A}$	2.3 V to 2.7 V	3 V to 3.6 V	0.2		
		$I_{OL} = 18 \text{ mA}$	2.3 V	3 V	0.55		
I_I	Control inputs	$V_I = V_{CCA}/V_{CCB}$ or GND	2.3 V to 2.7 V	3 V to 3.6 V	± 5		μA
$I_{OZ}^{(1)}$	A or B ports	$V_O = V_{CCA}/V_{CCB}$ or GND	2.3 V to 2.7 V	3 V to 3.6 V	± 10		μA
I_{CC}		$V_I = V_{CCA}/V_{CCB}$ or GND, $I_O = 0$	2.3 V to 2.7 V	3 V to 3.6 V	20		μA
$\Delta I_{CC}^{(2)}$		One input at $V_{CCA}/V_{CCB} - 0.6 \text{ V}$, Other inputs at V_{CCA}/V_{CCB} or GND	2.3 V to 2.7 V	3 V to 3.6 V	750		μA

(1) For I/O ports, the parameter I_{OZ} includes the input leakage current.

(2) This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than at 0 or the associated V_{CC} .

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1 through Figure 4)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$		$V_{CCB} = 5 \text{ V} \pm 0.5 \text{ V}$		UNIT		
			$V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$		$V_{CCA} = 2.7 \text{ V}$			$V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$	
			MIN	MAX	MIN	MAX		MIN	MAX
t_{pd}	A	B	7.6		5.9		ns		
	B	A	7.6		6.7				
t_{en}	\overline{OE}	B	11.5		9.3		ns		
t_{dis}	\overline{OE}	B	10.5		9.2		ns		
t_{en}	\overline{OE}	A	12.3		10.2		ns		
t_{dis}	\overline{OE}	A	9.3		9		ns		

OPERATING CHARACTERISTICS

$T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	$V_{CCB} = 3.3 \text{ V}$	$V_{CCB} = 5 \text{ V}$	UNIT
			$V_{CCA} = 2.5 \text{ V}$	$V_{CCA} = 3.3 \text{ V}$	
			TYP	TYP	
C_{pd}	Outputs enabled (B)	$C_L = 50 \text{ pF}, f = 10 \text{ MHz}$	55	56	pF
	Outputs disabled (B)		27	6	
	Outputs enabled (A)	$C_L = 50 \text{ pF}, f = 10 \text{ MHz}$	118	56	
	Outputs disabled (A)		58	6	

SN74ALVC164245 16-BIT 2.5-V TO 3.3-V/3.3-V TO 5-V LEVEL-SHIFTING TRANSCEIVER WITH 3-STATE OUTPUTS

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POWER-UP CONSIDERATIONS ⁽¹⁾

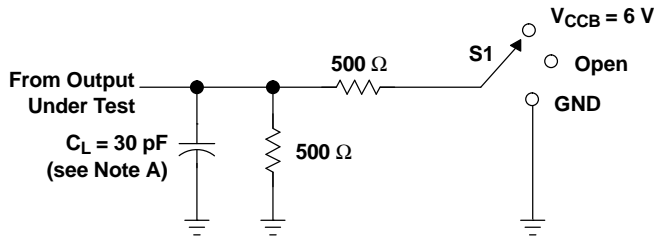
TI level-translation devices offer an opportunity for successful mixed-voltage signal design. A proper power-up sequence always should be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies caused by improperly biased device pins. Take these precautions to guard against such power-up problems:

1. Connect ground before any supply voltage is applied.
2. Power up the control side of the device (V_{CCA} for all four of these devices).
3. Tie \overline{OE} to V_{CCA} with a pullup resistor so that it ramps with V_{CCA} .
4. Depending on the direction of the data path, DIR can be high or low. If DIR high is needed (A data to B bus), ramp it with V_{CCA} . Otherwise, keep DIR low.

(1) Refer to the TI application report, *Texas Instruments Voltage-Level-Translation Devices*, literature number SCEA021.

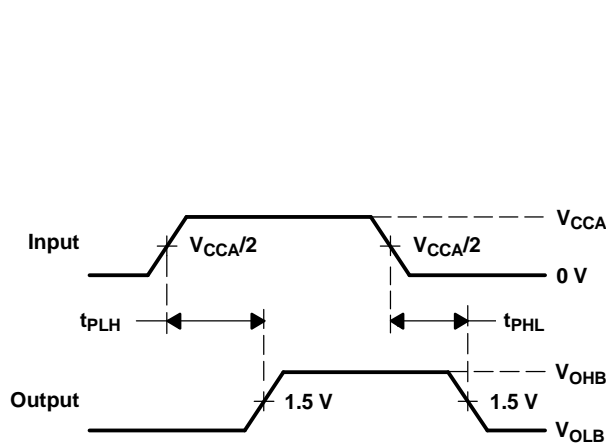
PARAMETER MEASUREMENT INFORMATION

$V_{CCA} = 2.5\text{ V} \pm 0.2\text{ V}$ TO $V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$

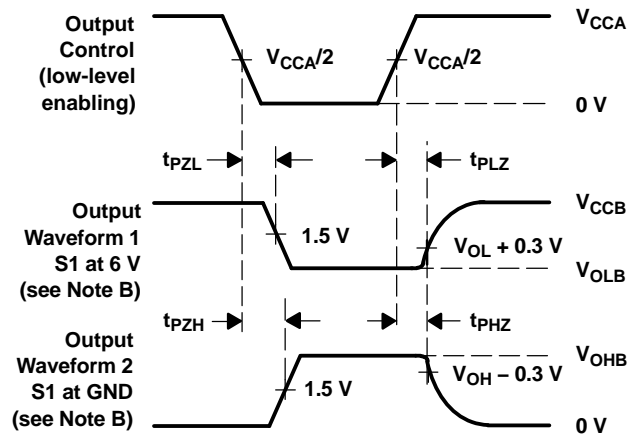


LOAD CIRCUIT

TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	$V_{CCB} = 6\text{ V}$
t_{PHZ}/t_{PZH}	GND



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 2\text{ ns}$, $t_f \leq 2\text{ ns}$.
 D. The outputs are measured one at a time, with one transition per measurement.
 E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 F. t_{PZL} and t_{PZH} are the same as t_{en} .
 G. t_{PLH} and t_{PHL} are the same as t_{pd} .

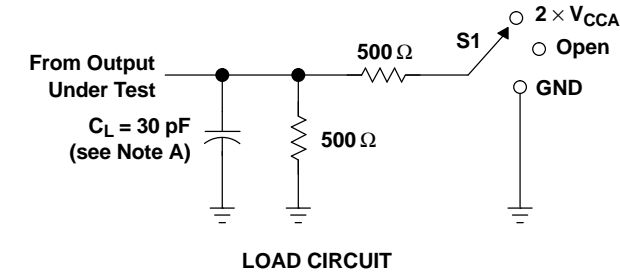
Figure 1. Load Circuit and Voltage Waveforms

SN74ALVC164245 16-BIT 2.5-V TO 3.3-V/3.3-V TO 5-V LEVEL-SHIFTING TRANSCEIVER WITH 3-STATE OUTPUTS

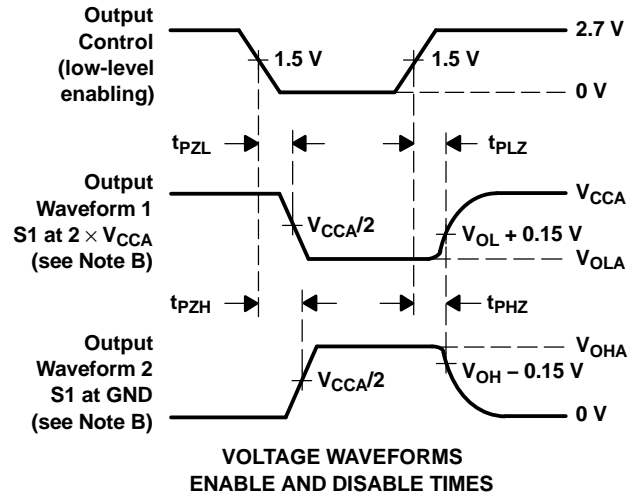
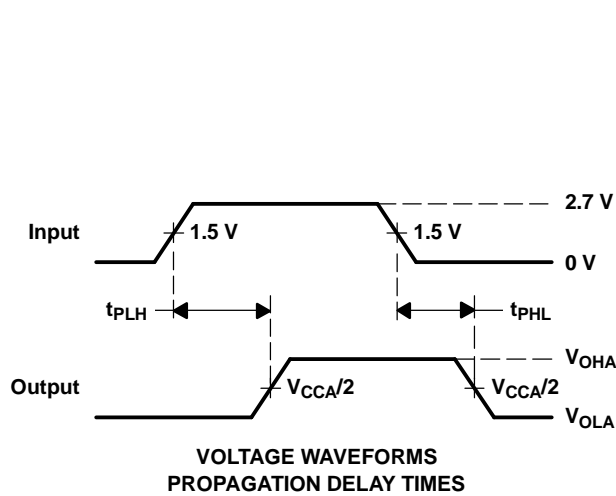
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PARAMETER MEASUREMENT INFORMATION

$$V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V TO } V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$$



TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	$2 \times V_{CCA}$
t_{PHZ}/t_{PZH}	GND

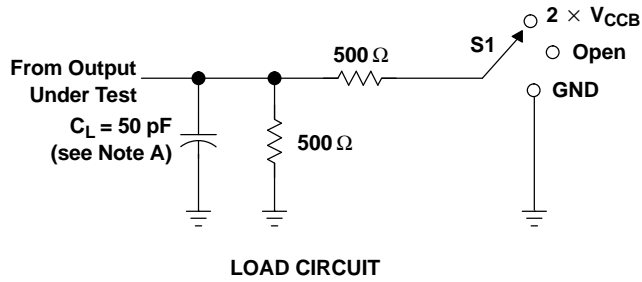


- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2 \text{ ns}$, $t_f \leq 2 \text{ ns}$.
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .

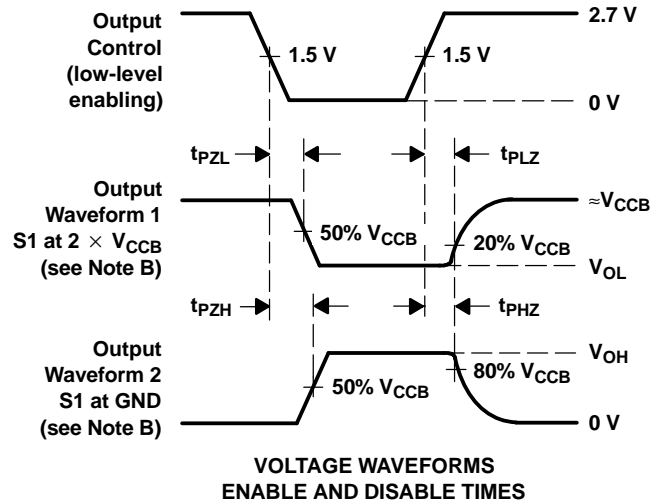
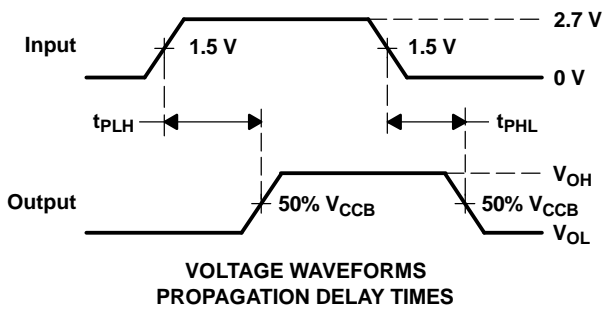
Figure 2. Load Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION

$V_{CCA} = 3.3\text{ V} \pm 0.3\text{ V}$ TO $V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$



TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	2 $\times V_{CCB}$
t_{PHZ}/t_{PZH}	GND



- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 2.5\text{ ns}$, $t_f \leq 2.5\text{ ns}$.
 D. The outputs are measured one at a time, with one transition per measurement.
 E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 F. t_{PZL} and t_{PZH} are the same as t_{en} .
 G. t_{PLH} and t_{PHL} are the same as t_{pd} .

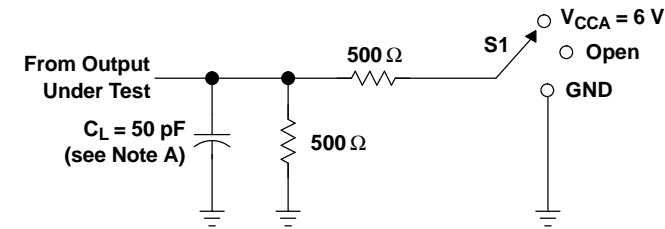
Figure 3. Load Circuit and Voltage Waveforms

SN74ALVC164245 16-BIT 2.5-V TO 3.3-V/3.3-V TO 5-V LEVEL-SHIFTING TRANSCEIVER WITH 3-STATE OUTPUTS

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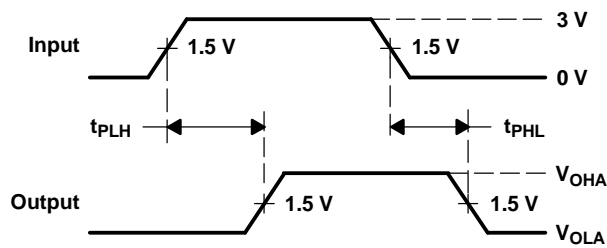
PARAMETER MEASUREMENT INFORMATION

$V_{CCB} = 5\text{ V} \pm 0.5\text{ V}$ TO $V_{CCA} = 2.7\text{ V}$ AND $3.3\text{ V} \pm 0.3\text{ V}$

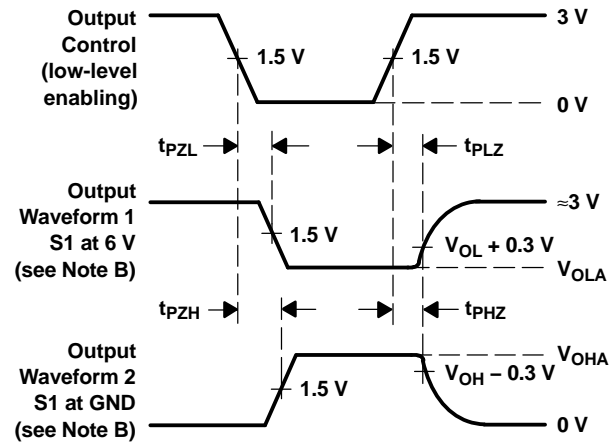


LOAD CIRCUIT

TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	$V_{CCA} = 6\text{ V}$
t_{PHZ}/t_{PZH}	GND



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



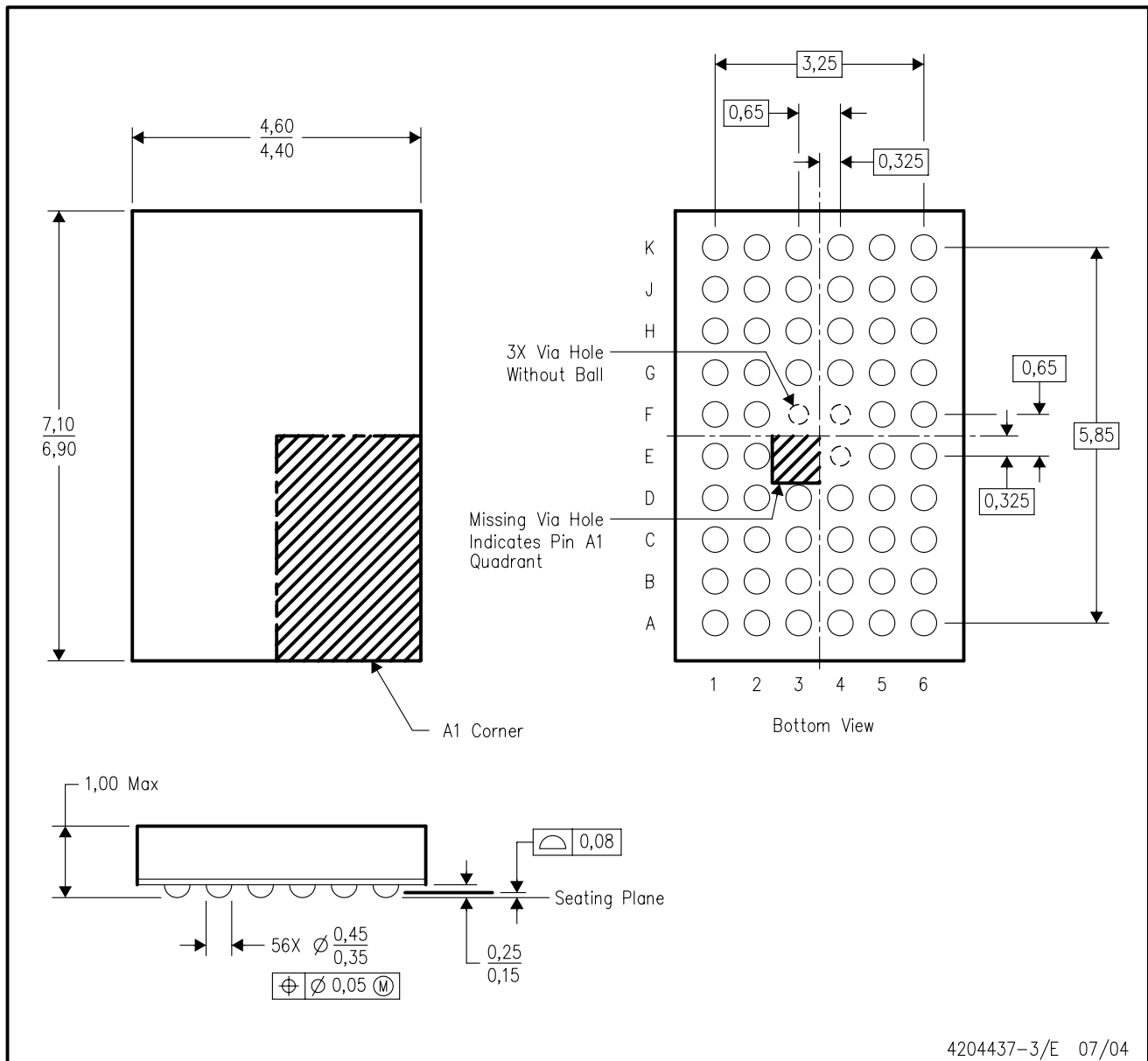
VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 2.5\text{ ns}$, $t_f \leq 2.5\text{ ns}$.
 D. The outputs are measured one at a time, with one transition per measurement.
 E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 F. t_{PZL} and t_{PZH} are the same as t_{en} .
 G. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 4. Load Circuit and Voltage Waveforms

ZQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY

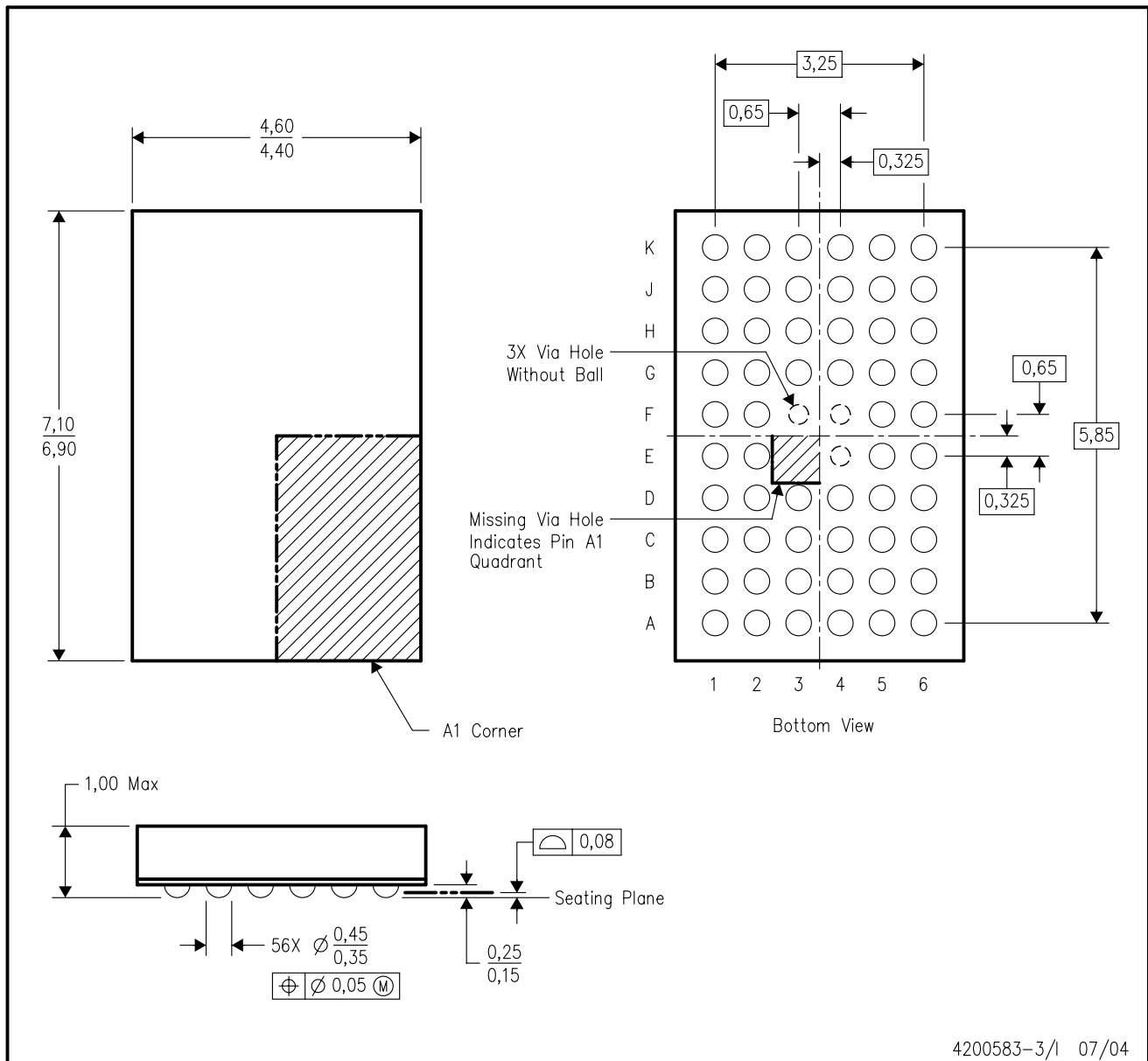


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- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MO-225 variation BA.
 - D. This package is lead-free. Refer to the 56 GQL package (drawing 4200583) for tin-lead (SnPb).

GQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY

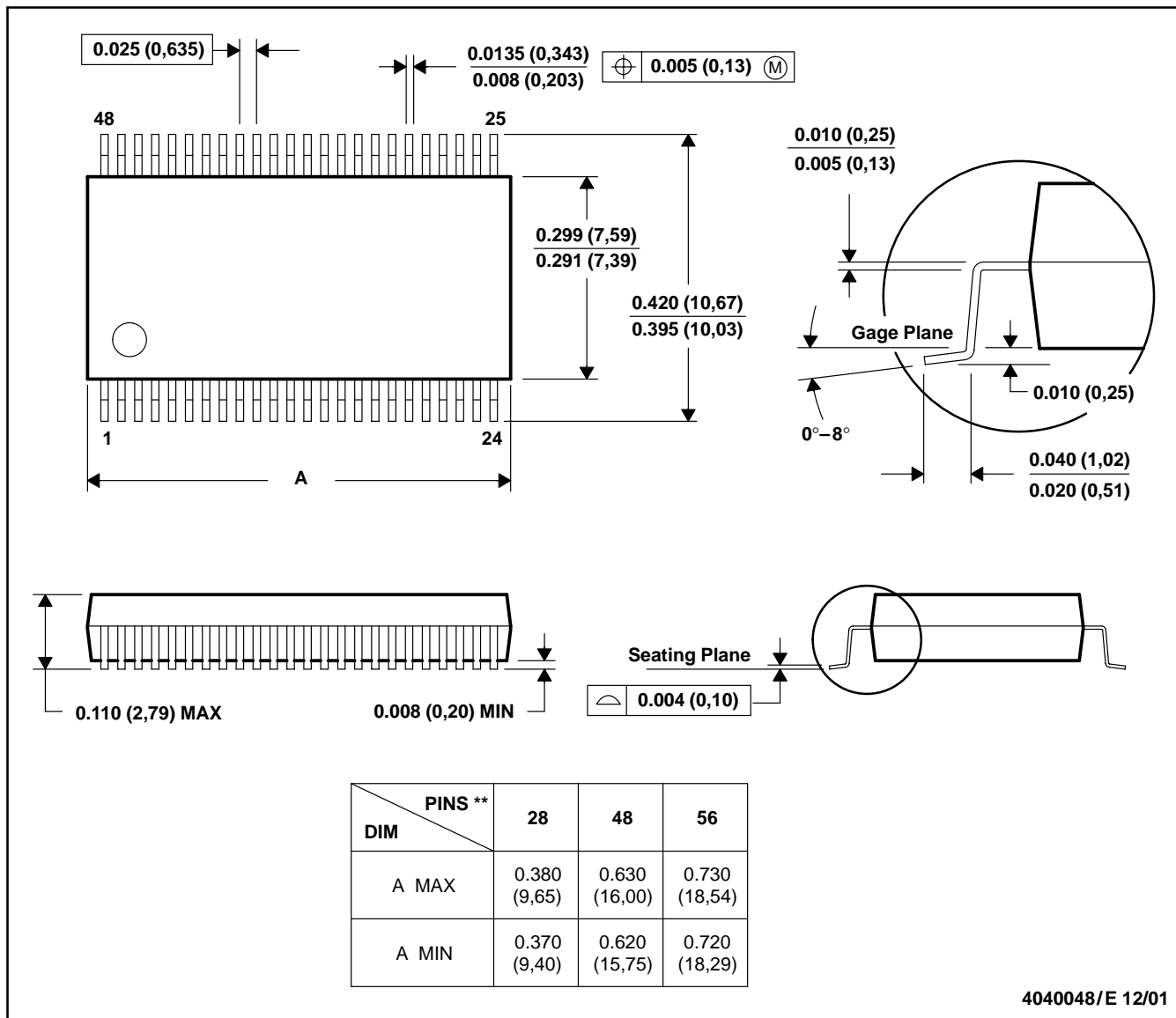


- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MO-225 variation BA.
 - D. This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.

DL (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 D. Falls within JEDEC MO-118

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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